You should delete the nylon screws/standoffs and/or the bumpers as needed for your design (or substitute other parts from Hardware.IntLib). Bumpers are cheaper, but provide less clearance.

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Update the Label Text in the Label Table as needed for each Assembly Variant.

You can delete this note too.

**Label Table**

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**Assembly Notes**

**ZH1**
These assemblies are ESD sensitive, ESD precautions shall be observed.

**ZH2**
These assemblies must be clean and free from flux and all contaminants. Use of no clean flux is not acceptable.

**ZH3**
These assemblies must comply with workmanship standards IPC-A-610 Class 2, unless otherwise specified.

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